

2x150 W/1x300 W class D digital input automotive power amplifier with diagnostics features and low voltage

Data brief



Features



- AEC-Q100 (rev. G) qualified
- Integrated 110 dB D/A conversion
- I²S and TDM digital input (3.3/1.8 V)
- Input sampling frequency: 44.1 kHz, 48 kHz, 96 kHz, 192 kHz
- Full I²C bus driving (3.3/1.8 V) with 8 different I²C bus addresses
- EMI control for FM/AM compatibility
- EMI compliance evaluated following normative IEC61967-4 and IEC62132-4
- Low radiation function (LRF)
- Very low quiescent current
- Output low-pass filter included in the feedback allowing outstanding audio performances
- Wide operating supply range: target 5.5 V-50 V
- MOSFET power outputs allowing high output power capability under step-up voltage:
 - 2 x 120 W /4 Ω @ 35 V, 1 kHz THD = 1% (2 x 150 W /4 Ω @ 35 V, 1 kHz THD = 10%)
 - 2 x 140 W /8 Ω @ 50 V, 1 kHz THD = 1% (2 x 180 W /8 Ω @ 50 V, 1 kHz THD = 10%)
 - 2 x 270 W /8 Ω @ 50 V max output power
- Operation under standard car battery with high output power:
 - 2 x 22 W /4 Ω @ 14 V, 1 kHz THD = 1% (2 x 28 W /4 Ω @ 14 V, 1 kHz THD = 10%)
 - 2 x 37 W /2 Ω @ 14 V, 1 kHz THD = 1% (2 x 46 W /2 Ω @ 14 V, 1 kHz THD = 10%)
- Possibility to drive 2 Ω loads (until 18 V)
- Independent channel operation
- I²C bus diagnostics:
 - Short to Vcc/GND diagnostic (including soft shorts up to 1k Ω)
 - DC load diagnostic
 - AC load diagnostic (working both with internally generated and externally generated tone)
- Integrated fault protection
- Input and output offset detector
- Clipping detector
- Legacy mode ('no I²C' mode)
- Short circuit and ESD integrated protections
- Package: LQFP64 exposed pad up

Table 1. Device summary

Order code	Package	Packing
FDA802-VYY	LQFP64 (exp. pad up)	Tray
FDA802-VYT	LQFP64 (exp. pad up)	Tape & reel

Contents

1	Description	3
2	Block and pins description diagrams	4
3	Package information	7
3.1	LQFP64 (10x10x1.4 mm exp. pad up) package information	7
3.2	LQFP64 (10x10x1.4 mm exp. pad up) marking information	9
4	Revision history	10

1 Description

The FDA802 is a dual bridge class D amplifier, designed in the most advanced BCD technology specially intended for car radio applications.

The FDA802 integrates a high performance D/A converter together with powerful MOSFET outputs in class D, to get an outstanding efficiency compared to the standard class AB.

The integrated D/A converter allows to reach outstanding performances (110 dB S/N ratio with 110 dB of dynamic range).

Thanks to the high-voltage MOSFET output stages it can operate both under standard car battery (6-18 V) and under boosted power supply (up to 50 V) to reach the highest possible power with integrated solution.

The feedback loop is including the output L-C low-pass filter, allowing superior frequency response linearity and lower distortion independently from the inductor and capacitor quality.

FDA802 is fully configurable through I²C bus interface and integrates a complete diagnostics array specially intended for automotive applications.

Thanks to the solutions implemented to solve the EMI problems, the device is intended to be used in the standard single DIN car-radio box together with the tuner.

Moreover FDA802 is able to work with power supply as low as 5.5 V, thus supporting the most recent low voltage ('start-stop') car-makers specification.

2 Block and pins description diagrams

Figure 1. Block diagram



Figure 2. Pins connection diagram



Table 2. Pins list description

N#	Pin	Function
1	FB1+	Channel 1, half bridge plus, Feedback
2	OUT1+	Channel 1, half bridge plus, Output
3	OUT1+	Channel 1, half bridge plus, Output
4	VCC1+	Channel 1, half bridge plus, Boosted Power Supply
5	VCC1-	Channel 1, half bridge minus, Boosted Power Supply
6	OUT1-	Channel 1, half bridge minus, Output
7	OUT1-	Channel 1, half bridge minus, Output
8	FB1-	Channel 1, half bridge minus, Feedback
9	GND1-	Channel 1, half bridge minus, Power Ground
10-13, 16-17, 19, 30-34, 36-39	N.C.	Not connected
14	Vbattery	Main battery voltage (14V)
15	Vbattery	Main battery voltage (14V)
18	Enable4	Chip Enable 4
20	Enable3	Chip Enable 3

Table 2. Pins list description (continued)

N#	Pin	Function
21	Enable2	Chip Enable 2
22	Enable1	Chip Enable 1
23	DGSVR	Negative Analog Supply V(SVR)-0.9V (Internally generated)
24	D1V8SVR	Positive Digital Supply V(SVR)+0.9V (Internally generated)
25	DVdd	Digital supply
26	Dgnd	Digital ground
27	CPump1	Charge Pump pin1
28	VddCP	Charge Pump output voltage
29	CPump2	Charge Pump pin2
35	Vbattery	Main battery voltage (14V)
40	GND2-	Channel 2, half bridge minus, Power Ground
41	FB2-	Channel 2, half bridge minus, Feedback
42	OUT2-	Channel 2, half bridge minus, Output
43	OUT2-	Channel 2, half bridge minus, Output
44	VCC2-	Channel 2, half bridge minus, Boosted Power Supply
45	VCC2+	Channel 2, half bridge plus, Boosted Power Supply
46	OUT2+	Channel 2, half bridge plus, Output
47	OUT2+	Channel 2, half bridge plus, Output
48	FB2+	Channel 2, half bridge plus, Feedback
49	TAB	Device slug connection
50	GND2+	Channel 2, half bridge plus, Power Ground
51	CD/Diag	Clip detector / diagnostic pin
52	I2CClk	I ² C clock
53	I2C-Data	I ² C Data Input
54	SAI Tx	I ² S/TDM Data 2 (Data output)
55	SAI Rx	I ² S/TDM Data 1 (Data input)
56	SAI Bit clk	I ² S/TDM Clock
57	SAI fs	I ² S/TDM Sws (Frame Sync Input)
58	Agnd	Analog ground
59	AVdd	Analog supply
60	AGSVR	Negative Analog Supply V(SVR)-2.5V (Internally generated)
61	A5VSVR	Positive Analog Supply V(SVR)+2.5V (Internally generated)
62	SVR	Supply Voltage Ripple Rejection Capacitor
63	HWMute	Hardware mute pin
64	GND1+	Channel 1, half bridge plus, Power Ground

3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.

ECOPACK® is an ST trademark.

3.1 LQFP64 (10x10x1.4 mm exp. pad up) package information

Figure 3. LQFP64 (10x10x1.4 mm exp. pad up) package outline



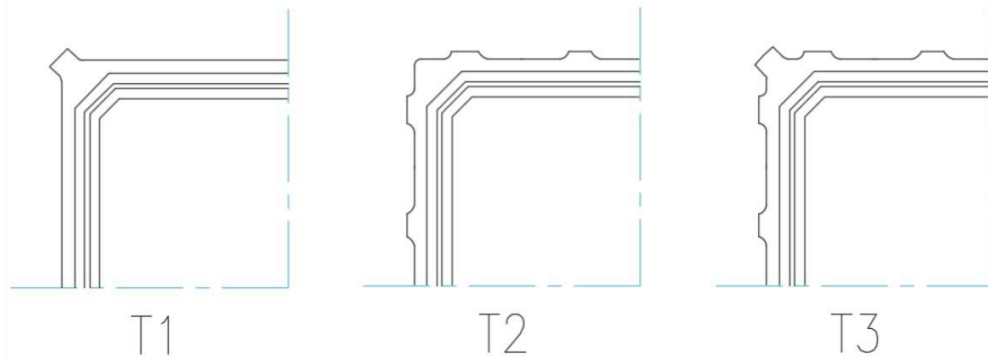
Table 3. LQFP64 (10x10x1.4 mm exp. pad up) package mechanical data

Symbol	Dimensions in mm		
	Min.	Typ.	Max.
Θ	0°	3.5°	6°
$\Theta 1$	0°	9°	12°
$\Theta 2$	11°	12°	13°
$\Theta 3$	11°	12°	13°
A	-	-	1.49
A1	-0.04	-	0.04
A2	1.35	1.4	1.45
b	-	-	0.27
b1	0.17	0.20	0.23
c	0.09	-	0.20
c1	0.09	0.127	0.16
D	12.00 BSC		
D1 ⁽¹⁾⁽²⁾	10.00 BSC		
D2	See VARIATIONS		
e	0.50 BSC		
E	12.00 BSC		
E1 ⁽¹⁾⁽²⁾	10.00 BSC		
E2	See VARIATIONS		
L	0.45	0.60	0.75
L1	1.00 REF		
N	-	64	-
R1	0.08	-	-
R2	0.08	-	0.20
S	0.20	-	-
Tolerance of form and position			
aaa	-	0.20	-
bbb	-	0.20	-
ccc	-	0.08	-
ddd	-	0.08	-

Table 3. LQFP64 (10x10x1.4 mm exp. pad up) package mechanical data (continued)

Symbol	Dimensions in mm		
	Min.	Typ.	Max.
VARIATIONS			
Pad option 6.0x6.0 (T1-T3)⁽³⁾			
D2	-	-	6.61
E2	-	-	6.61
D3	4.8	-	-
E3	4.8	-	-

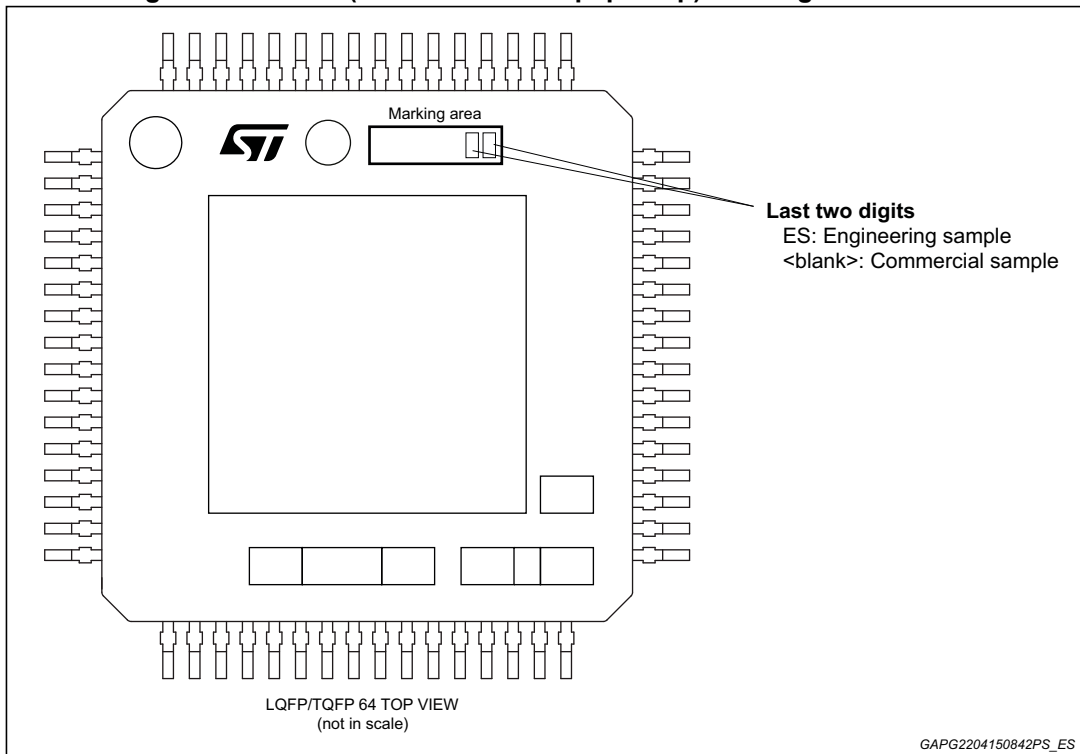
1. Dimensions D1 and E1 do not include mold flash or protrusions. Allowable mold flash or protrusion is "0.25 mm" per side.
2. The Top package body size may be smaller than the bottom package size by much as 0.15 mm.
3. Number, dimensions and position of shown grooves are for reference only:



GADG2108170827PS

3.2 LQFP64 (10x10x1.4 mm exp. pad up) marking information

Figure 4. LQFP64 (10x10x1.4 mm exp. pad up) marking information



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4 Revision history

Table 4. Document revision history

Date	Revision	Changes
14-Jun-2017	1	Initial release.
22-Aug-2017	2	Updated <i>LQFP64 (10x10x1.4 mm exp. pad up) package information.</i>

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